AUTOMOTIVE

RoHS

COMPLIANT

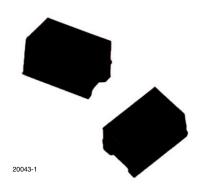
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(5-2008)3



Vishay Semiconductors

Silicon Phototransistor in 0805 Package



DESCRIPTION

TEMT7100X01 is a silicon NPN epitaxial planar phototransistor with daylight blocking filter in a miniature, black 0805 package for surface mounting. Filter bandwidth is matched with 830 nm to 950 nm IR emitters.

FEATURES

- Package type: surface mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- High photo sensitivity
- Daylight blocking filter matches with 830 nm to 950 nm IR emitters
- Angle of half sensitivity: $\varphi = \pm 60^{\circ}$
- Package matched with IR emitter series VSMB1940X01
- Floor life: 168 h, MSL 3, acc. J-STD-020
- · Lead (Pb)-free reflow soldering
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

Note

** Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

APPLICATIONS

- · Detector in automotive applications
- Photo interrupters
- · Miniature switches
- Counters
- Encoders
- Position sensors

PRODUCT SUMMARY				
COMPONENT	I _{caE} (μΑ)	φ (deg)	λ _{0.5} (nm)	
TEMT7100X01	225 to 675	± 60	750 to 1010	

Note

• Test condition see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
TEMT7100X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	0805	

Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Collector emitter voltage		V _{CEO}	20	V		
Emitter collector voltage		V _{ECO}	7	V		
Collector current		I _C	20	mA		
Power power dissipation	T _{amb} ≤ 55 °C	P _V	100	mW		
Junction temperature		T _j	100	°C		
Operating temperature range		T _{amb}	- 40 to + 100	°C		
Storage temperature range		T _{stg}	- 40 to + 100	°C		
Soldering temperature	Acc. reflow profile fig. 8	T _{sd}	260	°C		
Thermal resistance junction/ambient	Acc. J-STD-051	R _{thJA}	270	K/W		



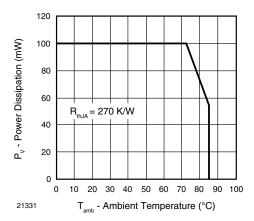


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Collector emitter breakdown voltage	I _C = 0.1 mA	V_{CEO}	20			V
Collector dark current	$V_{CE} = 5 \text{ V}, E = 0$	I _{CEO}		1	100	nA
Collector emitter capacitance	V _{CE} = 0 V, f = 1 MHz, E = 0	C _{CEO}		25		pF
Collector light current	E_e = 1 mW/cm ² , λ = 950 nm, V_{CE} = 5 V	I _{CA}	225	450	675	μΑ
Angle of half sensitivity		φ		± 60		deg
Wavelength of peak sensitivity		λ_{p}		870		nm
Range of spectral bandwidth		λ _{0.5}		750 to 1010		nm
Collector emitter saturation voltage	$I_{\rm C} = 0.05 \; {\rm mA}$	V _{CEsat}			0.4	V
Temperature coefficient of I _{ca}	E_e = 1 mW/cm ² , λ = 950 nm, V_{CE} = 5 V	Tk _{lca}		1.1		%/K

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

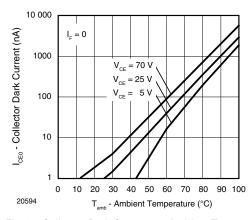


Fig. 2 - Collector Dark Current vs. Ambient Temperature

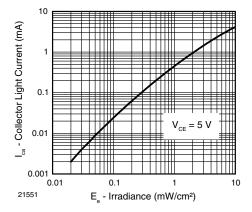


Fig. 3 - Collector Light Current vs. Irradiance

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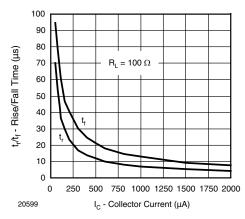


Fig. 4 - Rise/Fall Time vs. Collector Current

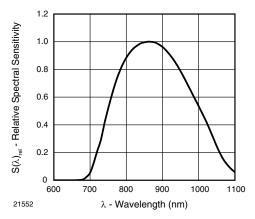


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

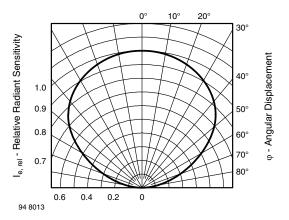


Fig. 6 - Relative Radiant Sensitivity vs. Angular Displacement

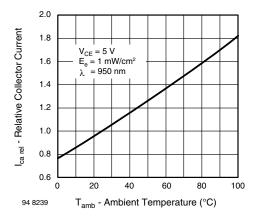


Fig. 7 - Relative Collector Current vs. Ambient Temperature

REFLOW SOLDER PROFILE

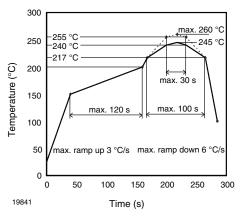


Fig. 8 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

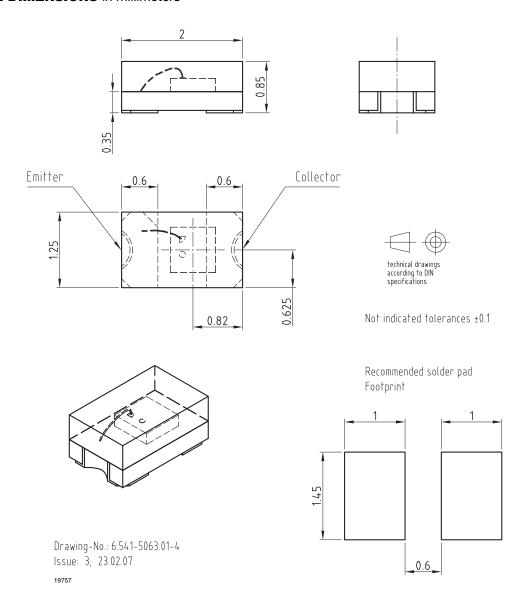
Moisture sensitivity level 3, acc. to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

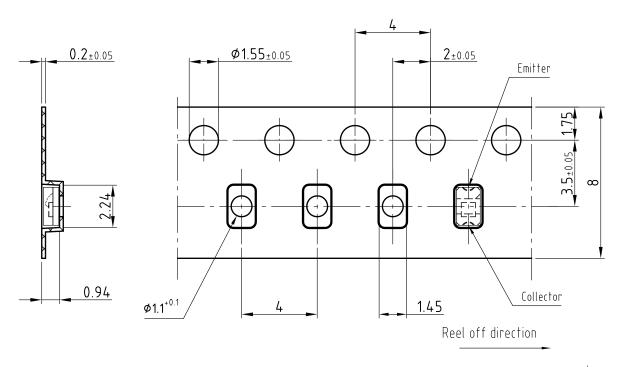
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PACKAGE DIMENSIONS in millimeters



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BLISTER TAPE DIMENSIONS in millimeters



Drawing-No.: 9.700-5310.01-4

Issue: 2; 14.08.07

20690

Not indicated tolerances ±0.1

Quantity per reel: 3000 pcs

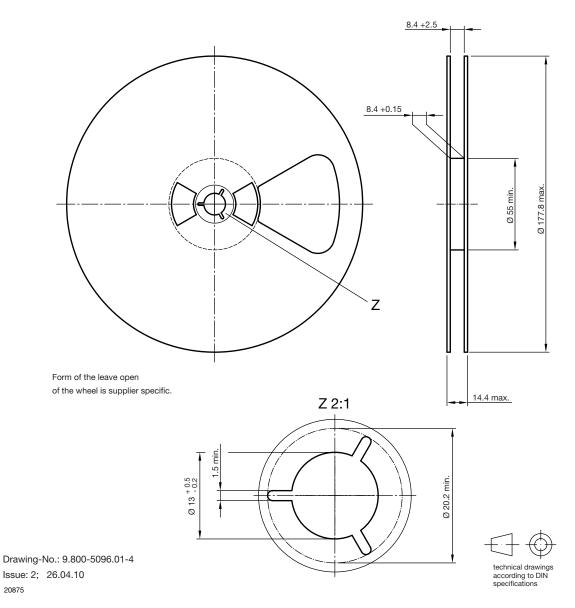


technical drawings according to DIN specifications

20875

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REEL DIMENSIONS in millimeters





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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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